

3.2mmx1.6mm SMD CHIP LED LAMP

Part Number: APT3216MGC Mega Green



ATTENTION OBSERVE PRECAUTIONS FOR HANDLING **ELECTROSTATIC** DISCHARGE SENSITIVE **DEVICES**

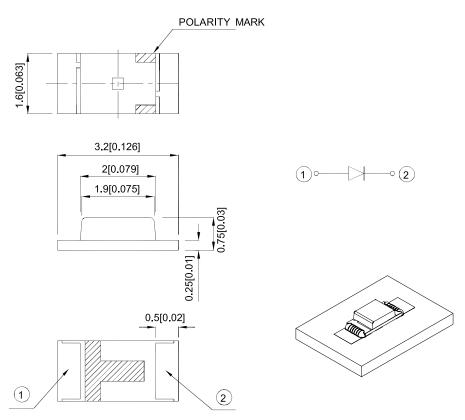
Features

- 3.2mmx1.6mm SMD LED, 0.75mm thickness.
- Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

Descriptions

- The Mega Green source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.
- Electrostatic discharge and power surge could damage the LEDs.
- It is recommended to use a wrist band or antielectrostatic glove when handling the LEDs.
- All devices, equipments and machineries must be electrically grounded.

Package Dimensions



SPEC NO: DSAB4203

APPROVED: Wynec

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.2 (0.008")$ unless otherwise noted.
- 3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

 4. The device has a single mounting surface. The device must be mounted according to the specifications.

REV NO: V.13B DATE: NOV/09/2016 PAGE: 1 OF 5 **CHECKED: Allen Liu** DRAWN: W.Q.Zhong ERP: 1203001934



Selection Guide

Part No.	lo. Emitting Color (Material) Lens Type		lv (mcd) [2] @ 20mA		Viewing Angle [1]
		3,1	Min.	Тур.	201/2
APT3216MGC	Mega Green (AlGaInP)	Water Clear	20	60	140°

Notes:

- 1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- 2. Luminous intensity / luminous Flux: +/-15%
- 3. Luminous intensity value is traceable to CIE127-2007 standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Emitting Color	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Mega Green	574		nm	IF=20mA
λD [1]	Dominant Wavelength	Mega Green	570		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Mega Green	26		nm	I=20mA
С	Capacitance	Mega Green	20		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Mega Green	2.1	2.5	V	I=20mA
lr	Reverse Current	Mega Green		10	uA	V _R =5V

- Wavelength: +/-1nm.
 Forward Voltage: +/-0.1V.
- 3. Wavelength value is traceable to CIE127-2007 standards.
- 4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

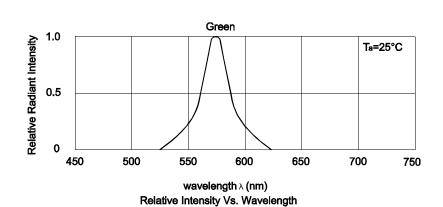
Absolute Maximum Ratings at TA=25°C

Parameter	Values	Units		
Power dissipation	75	mW		
DC Forward Current	30	mA		
Peak Forward Current [1]	150	mA		
Reverse Voltage	5	V		
Operating Temperature	-40°C To +85°C			
Storage Temperature	-40°C To +85°C			

- 1. 1/10 Duty Cycle, 0.1ms Pulse Width.
- 2. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

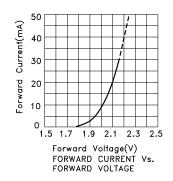
SPEC NO: DSAB4203 **REV NO: V.13B DATE: NOV/09/2016** PAGE: 2 OF 5 APPROVED: Wynec **CHECKED: Allen Liu** DRAWN: W.Q.Zhong ERP: 1203001934

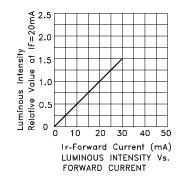
Kingbright

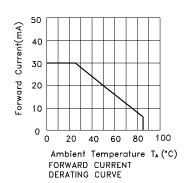


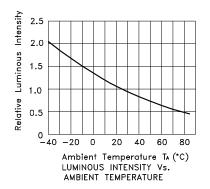
Mega Green

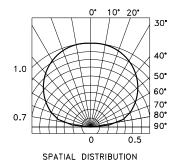
APT3216MGC











SPEC NO: DSAB4203 APPROVED: Wynec REV NO: V.13B CHECKED: Allen Liu DATE: NOV/09/2016 DRAWN: W.Q.Zhong PAGE: 3 OF 5

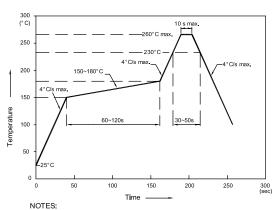
ERP: 1203001934

Kingbright

APT3216MGC

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMD Process.

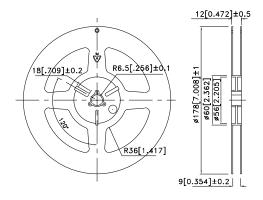


- 1. We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.
- 2 Don't cause stress to the epoxy resin while it is exposed
- to high temperature.
 3.Number of reflow process shall be 2 times or less.

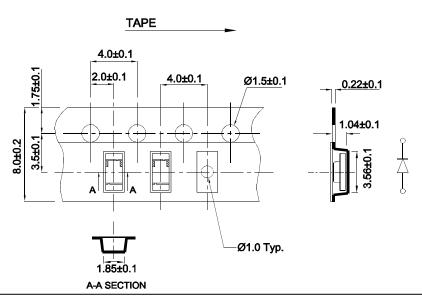
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)

1.75 2.0 1.75

Reel Dimension



Tape Dimensions (Units : mm)

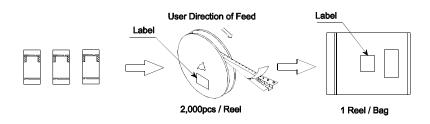


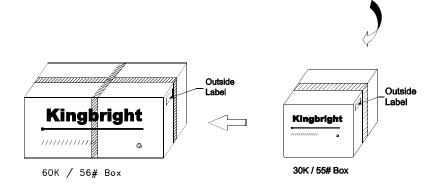
SPEC NO: DSAB4203 APPROVED: Wynec REV NO: V.13B CHECKED: Allen Liu DATE: NOV/09/2016 DRAWN: W.Q.Zhong PAGE: 4 OF 5 ERP: 1203001934

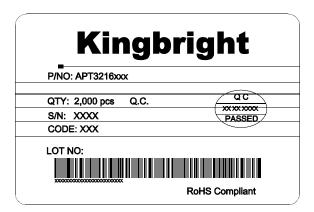
Kingbright

PACKING & LABEL SPECIFICATIONS

APT3216MGC







Terms and conditions for the usage of this document

- 1. The information included in this document reflects representative usage scenarios and is intended for technical reference only.
- 2. The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
- 3. When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.
- 4. The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening liabilities, such as automotive or medical usage, please consult with Kingbright representative for further assistance.
- 5. The contents and information of this document may not be reproduced or re-transmitted without permission by Kingbright.
- 6. All design applications should refer to Kingbright application notes available at http://www.KingbrightUSA.com/ApplicationNotes

 SPEC NO: DSAB4203
 REV NO: V.13B
 DATE: NOV/09/2016
 PAGE: 5 OF 5

 APPROVED: Wynec
 CHECKED: Allen Liu
 DRAWN: W.Q.Zhong
 ERP: 1203001934